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## the United States Patent and Trademark Office

In re the Application of Lee D. Whetsel

TI-20787.2

Serial No. 09/697,941

Art Unit: 2829

Filed: 10/26/2000

Examiner: Nguyen,

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marka
slinka

Title: Fault Tolerant Selection of Die on Wafer

Amendment A Under 37 CFR 1.111

COPY OF PAPERS ORIGINALLY FILED

July 3, 2002

Assistant Commissioner For Patents Washington, D. C. 20231

Dear Sir:

MAILING CERTIFICATE UNDER 37 C.F.R. \$1.8(A) I hereby certify that the above correspondence is being deposited with the U.S. Postal Service as First class Mail in an envelope addressed to: Assistant Commissioner For Patents, Washington 20231 on July 3, 2002.

Responsive to the Examiner's Action of February 11, 2002, please amend this application as follows:

## In the Title:

Amend the title to read as follows: --Integrated Circuit Die With Bypass Bond Pad--

## In the Specification:

Page 1, before line 1, insert:

is a divisional of Application No. application 09/416,562, filed October 12, 1999, now US 6,166,557; which was a divisional of Application No. 08/741,457, filed October 31, 1996,

07/15/2002 BABRAHA1 00000029 200668 | 09697941

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Art Unit: 2829

Examiner: Nguyen, Vinh P.

Title: Fault Tolerant Selection of Die on Wafer

July 3, 2002

Assistant Commissioner for Patents Washington, D. C. 20231 MAILING CERTIFICATE UNDER 37 C.F.R. \$1.8(a) I hereby certify that the above correspondence is being mailed by First Class Mail in an envelope addressed to: Commissioner of Patents and Trademarks, Washington, D.C. 20231 on July 3, 2002

Dawrence J. Bassuk, Reg No. 29,043

Dear Sir:

Transmitted herewith is an amendment in this application.

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The fee has been calculated as shown below.

		CI	LAIMS AS AMEND	ED		
	CLAIMS REMAINING AFTER AMENDMENT		HIGHEST NUMBER PREVIOUSLY PAID FOR	PRESENT EXTRA	RATE	ADDITIONAL FEE
Total Claims	32	Minus	20	= 12	x \$18 =	\$ 216
Ind. Claims	10	Minus	3.	= 7	x \$84 =	\$ 588
TOTAL ADDITIONAL FEE FOR THIS AMOUNT						\$ 804

Under 37 C.F.R. § 1.16(k) please charge the total additional fee, and any further fees, or credit overpayment to Deposit Account No. 20-0668 of Texas Instruments Incorporated.

Texas Instruments Incorporated P.O. Box 655474, M/S 3999 Dallas, Texas 75265 (972) 917-4418 Lawrence J. Bassuk Reg. No. 29,043

Attorney for Applicant